IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application S	erial No. .	nown
	Filed Here	
Assignee .		, Inc.
	t	
Examiner .		nown
Attorney's Do	cket No Ml22-2	2236
	Semiconductor Processing Patterning Methods and Construction	

POWER OF ATTORNEY BY ASSIGNEE AND CERTIFICATE BY ASSIGNEE UNDER 37 CFR § 3.73(b)

To: Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Sir:

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MICRON TECHNOLOGY, INC., the Assignee of the entire right, title and interest in the above-identified patent application by assignment attached hereto, hereby appoints the attorneys and agents of the firm of WELLS ST. JOHN P.S., listed as follows:

Reg.	No.	23,032
Reg.	No.	30,386
Reg.	No.	32,268
Reg.	No.	33,560
Reg.	No.	32,356
Reg.	No.	38,533
Reg.	No.	31,166
Reg.	No.	37,144
Reg.	No.	39,833
Reg.	No.	44,854
Reg.	No.	40,045
Reg.	No.	48,711
Reg.	No.	46,791
Reg.	No.	40,246
	Reg. Reg. Reg. Reg. Reg. Reg. Reg. Reg.	Reg. No.

and also attorneys Michael L. Lynch (Reg. No. 30,871), Charles B. Brantley II (Reg. No. 38,086) and Russel D. Slifer (Reg. No. 39,838) of Micron

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Technology, Inc., as its attorneys with full power of substitution to prosecute this application and transact all business in the Patent and Trademark Office connected therewith.

The Assignee certifies that the above-identified Assignment has been reviewed and to the best of Assignee's knowledge and belief, title is in the Assignee, and a copy of the Assignment is submitted herewith.

Please direct all correspondence regarding this application to:

Customer No. 021567 Wells St. John P.S. Attn: Robert C. Hyta 601 West First Avenue, Suite 1300 Spokane, WA 99201-3828 Telephone: (509) 624-4276

(509) 838-3424

MICRON TECHNOLOGY, INC.

Dated: 6-18-03 By: 2

Facsimile:

Name: Michael L. Lynch, Esq.

Title: Chief Patent Counsel

Attachments: Copy of Assignment, Copy of Board of Directors' Resolution

DECLARATION OF SOLE INVENTOR FOR PATENT APPLICATION

As the below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled: Semiconductor Processing Patterning Methods and Constructions, the specification of which is attached hereto.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims.

I acknowledge the duty to disclose information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations § 1.56.

PRIOR FOREIGN APPLICATIONS:

I hereby state that no applications for foreign patents or inventor's certificates have been filed prior to the date of execution of this declaration.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statement may jeopardize the validity of the application or any patent issued therefrom.

* * * * * * * * * *

Full name of sole inventor:	Donald L. Yates
Inventor's Signature:	July Max
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